

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT2673003

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>ZHI-QI WANG</td><td>01/08/2014</td></tr><tr><td>QIONG YU</td><td>01/08/2014</td></tr><tr><td>WEI WANG</td><td>01/08/2014</td></tr></tbody></table>		Name	Execution Date	ZHI-QI WANG	01/08/2014	QIONG YU	01/08/2014	WEI WANG	01/08/2014				
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<table border="1"><tr><td>Name:</td><td>CHINA WAFER LEVEL CSP CO., LTD.</td></tr><tr><td>Street Address:</td><td>29 TINGLAN LANE</td></tr><tr><td>Internal Address:</td><td>SUZHOU INDUSTRIAL PARK</td></tr><tr><td>City:</td><td>SUZHOU</td></tr><tr><td>State/Country:</td><td>CHINA</td></tr><tr><td>Postal Code:</td><td>215126</td></tr></table>		Name:	CHINA WAFER LEVEL CSP CO., LTD.	Street Address:	29 TINGLAN LANE	Internal Address:	SUZHOU INDUSTRIAL PARK	City:	SUZHOU	State/Country:	CHINA	Postal Code:	215126
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CORRESPONDENCE DATA													
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ATTORNEY DOCKET NUMBER:	200227.401												
NAME OF SUBMITTER:	TIMOTHY L. BOLLER												

Signature:	/Timothy L. Boller/
Date:	01/08/2014
Total Attachments: 3 source=Assignment document for execution.pdf#page1.tif source=Assignment document for execution.pdf#page2.tif source=Assignment document for execution.pdf#page3.tif	

ASSIGNMENT

WHEREAS, we, Zhi-Qi WANG, Qiong YU and Wei WANG (hereinafter referred to as ASSIGNORS), all having a mailing address of 29 Tinglan Lane, Suzhou Industrial Park, Suzhou, China 215126, are the joint inventors of an invention entitled "WAFER-LEVEL PACKAGING METHOD OF BSI IMAGE SENSORS HAVING DIFFERENT CUTTING PROCESSES," as described and claimed in the specification for which an application for United States letters patent was filed on January 8, 2014, and assigned Application No. 14/150,307;

WHEREAS, China Wafer Level CSP Co., Ltd. (hereinafter referred to as ASSIGNEE), a corporation China having a place of business at 29 Tinglan Lane, Suzhou Industrial Park, Suzhou, China 215126, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto said ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions including any extensions or adjustments in term thereof and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, and including the right to sue and collect damages for past and present infringement of said letters patent; said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

Application No. 14/150,307

Assignee's counsel is authorized to insert the official filing date and application number information when it becomes available.

2014.1.8
Date

Zhi-Qi Wang
Zhi-Qi WANG

I certify that I know or have satisfactory evidence that Zhi-Qi WANG is the person who appeared before me, and said person acknowledged that he signed this instrument and acknowledged it to be his free and voluntary act for the uses and purposes mentioned in the instrument.

Dated 2014.1.8

Signature of
Witness Qi Wang

2014.1.8
Date

Qiong YU
Qiong YU

I certify that I know or have satisfactory evidence that Qiong YU is the person who appeared before me, and said person acknowledged that he signed this instrument and acknowledged it to be his free and voluntary act for the uses and purposes mentioned in the instrument.

Dated 2014.1.8

Signature of
Witness Qi Wang

Application No. 14/150,307

Date

2014.1.8

Wei WANG

Wei Wang

I certify that I know or have satisfactory evidence that Wei WANG is the person who appeared before me, and said person acknowledged that he signed this instrument and acknowledged it to be his free and voluntary act for the uses and purposes mentioned in the instrument.

Dated

2014.1.8

Signature of
Witness

Qi Wang

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